HARDWARE ROADMAP

From Idea to Manufacturing



PRODUCT DESIGN STAGE



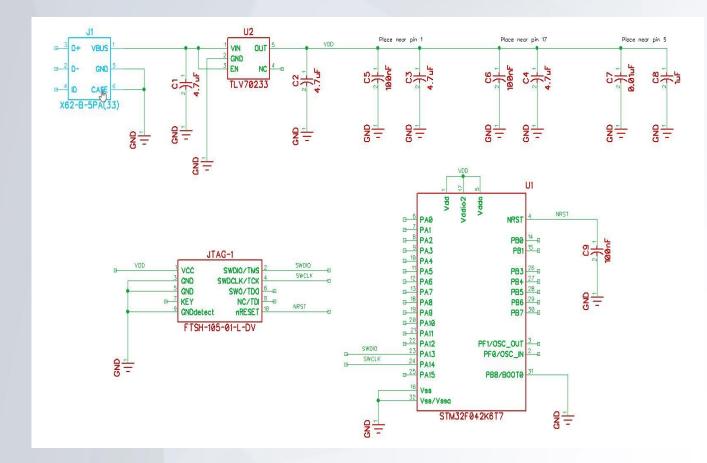




Design the Schematic Circuit Diagram



Step 6 Design Schematic Circuit Diagram



- Conceptual diagram like a blueprint
- Interconnection of all electronic components
- Dozens of software packages for designing schematics and PCB







Create the Bill of Materials (BOM)



Step 7 Create the Bill of Materials (BOM)

- Automatically created by schematic software
- Include all part numbers in schematic
- Use BOM for calculating manufacturing cost
- Excel/Sheets vs BOM software





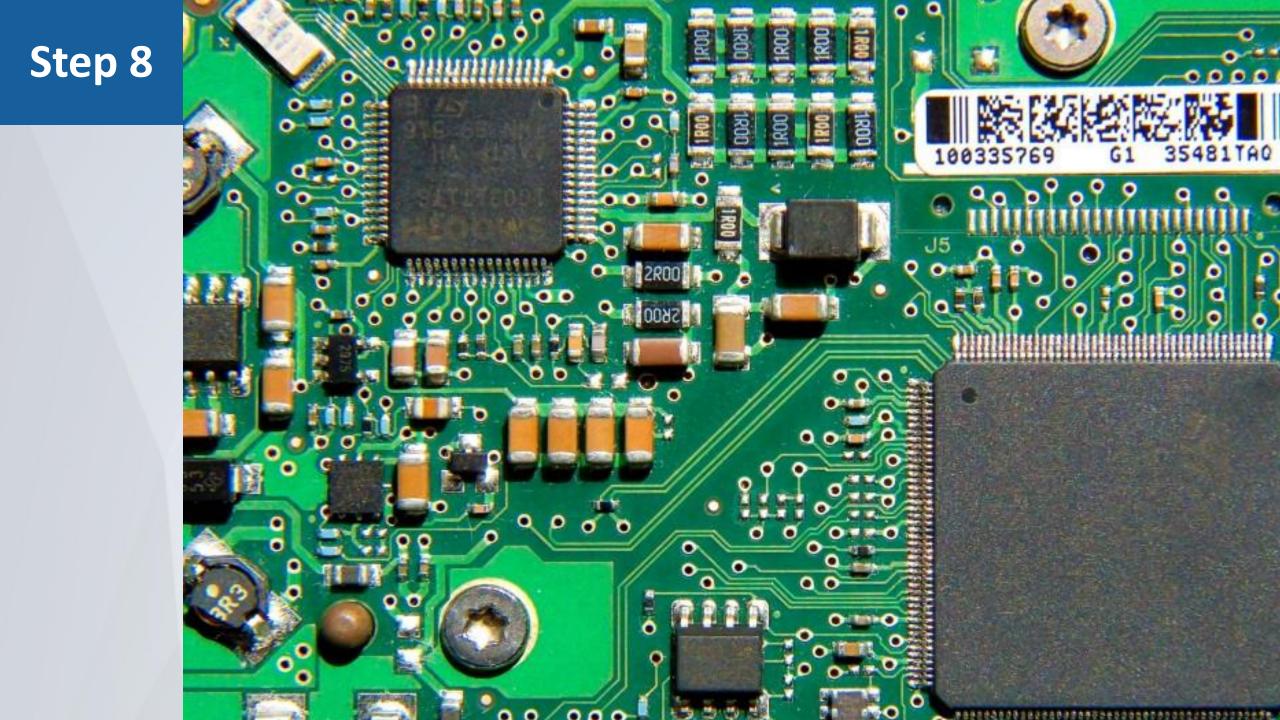
Design the Printed Circuit Board (PCB)



Step 8 Design the Printed Circuit Board (PCB)

- Physical board that holds and connects
 electronic components
- Stacked routing/component layers separated by insultation layers
- Created in same software as schematic
- High power, wireless, audio, and processors most complex to layout







Develop the Software



Step 9 Develop the Software

- Embedded firmware (low-level, C/C++, EE)
- Mobile application (high-level, CS)
- Computer software (high-level, CS)
- Cloud programming (high-level, CS)





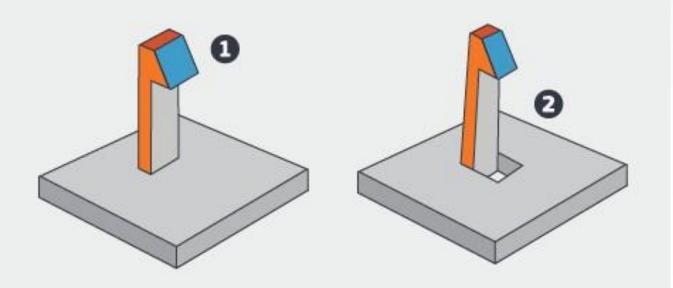


- Prototypes = 3D printing or CNC machining
- Production = High pressure injection molding
- Designing for injection molding
 - Consider from the start of the design
 - Finalize after final prototype



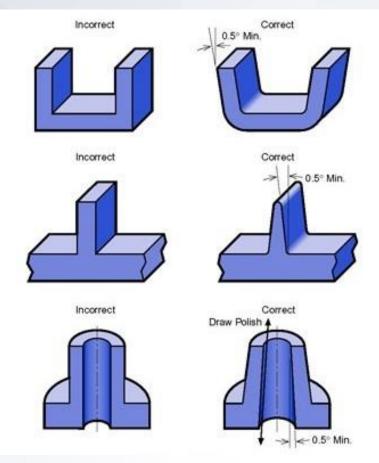
- Undercuts
- Draft
- Ejector pin marks
- Uniform wall thickness
- Radius/chamfer corners
- Parting line





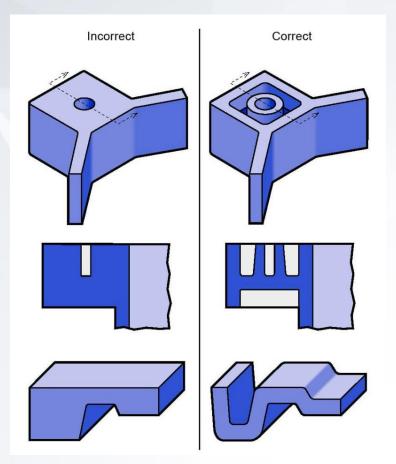
Avoid undercuts when possible to simplify mold and lower cost.





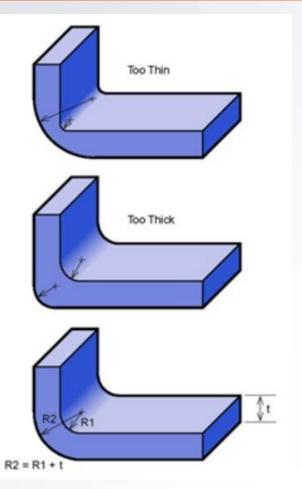
Draft is required to remove part from mold.





Uniform wall thickness is important for injection molding.





Corners must be rounded while maintaining uniform thickness





Get Independent Design Reviews



Step 11 Get Independent Design Reviews

- Reviews reduce design errors
- All established tech companies require reviews
- Saves money and speeds up time to market
- Review both electronics and mechanicals

